

# MN101D08E

VTR Servo

<b>Type</b>	MN101D08E	
<b>ROM (x8-bit)</b>	80 K	
<b>RAM (x8-bit)</b>	2 K	
<b>Package</b>	LQFP080-P-1414A *Lead-free	
<b>Minimum Instruction Execution Time</b>	With main clock operated	0.1397 $\mu$ s (at 4.0 V to 5.5 V, 14.32 MHz)
	When sub-clock operated	71.5 $\mu$ s (at 2.7 V to 5.5 V fixed to 14.32 MHz internal frequency division)
		61 $\mu$ s (at 2.5 V to 5.5 V, 32.768 kHz)
<b>Interrupts</b>	<ul style="list-style-type: none"> <li>• RESET • Runaway • External 0, 1, 2, 3, 4 • Timer 0 • Timer 1 • Timer 2 • Timer 3 • Timer 6</li> <li>• Capstan FG • Control • HSW • Cylinder FG • Servo VSYNC • Synchronous output • OSD • XDS • Serial 1</li> <li>• Serial 2 • PWM 4 • OSDVSYNC</li> </ul>	
<b>Timer Counter</b>	<p>Timer counter 0: 8-bit <math>\times</math> 1 (timer function)</p> <p>Clock source ..... 1/4, 1/16 of system clock frequency</p> <p>Interrupt source ..... overflow of timer counter 0</p> <p>Timer counter 1: 8-bit <math>\times</math> 1 (timer function, linear timer counter function)</p> <p>Clock source ..... 1/4 of system clock frequency; CTL signal</p> <p>Interrupt source ..... overflow of timer counter 1</p> <p>Timer counter 2: 16-bit <math>\times</math> 1 (timer function, input capture (DCTL specified edge), duty judgment of DCTL signal)</p> <p>Clock source ..... 1/4, 1/16, 1/24 of system clock frequency</p> <p>Interrupt source ..... overflow of timer counter 2; input of DCTL specified edge; underflow of timer 2 shift register 4-bit counter; coincidence of timer 2 shift register with timer 2 shift register compare register</p> <p>Timer counter 3: 16-bit <math>\times</math> 1 (timer function, detection of serial indexing, generation of remote control output carrier frequency)</p> <p>Clock source ..... 1/4, 1/16 of system clock frequency</p> <p>Interrupt source ..... overflow of timer counter 3</p> <p>Timer counter 5: 19-bit <math>\times</math> 1 (watchdog, stable oscillation waiting function)</p> <p>Clock source ..... system clock</p> <p>Watchdog interrupt source .. 1/2<sup>16</sup>, 1/2<sup>19</sup> of timer counter 5 frequency</p> <p>Clear by stable oscillation .. after 256 counts by timer counter 5 (2<sup>18</sup> counts of OSC oscillation clock)</p> <p>Timer counter 6: 16-bit <math>\times</math> 1 (clock function [max. 2 s])</p> <p>Clock source ..... 1/512 of OSC oscillation clock frequency; XI oscillation clock; 1/8, 1/128 of system clock frequency</p> <p>Interrupt source ..... 1/2<sup>13</sup>, 1/2<sup>14</sup>, 1/2<sup>15</sup> overflow of timer counter 6</p>	
<b>Serial Interface</b>	<p>Serial 1: 8-bit <math>\times</math> 1 (synchronous type/remote control transmission/simple remote control receive) (transfer direction of MSB/LSB selectable, start condition function)</p> <p>Clock source ..... 1/8, 1/16, 1/32, 1/64, 1/128, 1/256 of system clock frequency; <math>\overline{\text{SBT1}}</math> pin input</p> <p>Serial 2: 8-bit <math>\times</math> 1 (I<sup>2</sup>C) (master transmission/reception, slave transmission/reception)</p> <p>Clock source ..... 1/144 to 1/252 of system clock; SCK pin input</p>	

<b>OSD</b>	OSD mode:Accommodation with menu or super impose display		
	Applicable broadcasting system : NTSC, PAL, PAL-M, PAL-N		
	Screen configuration : 24 characters × 2n rows (n = 1 to 6)		
	Character type : max. 128 character types (variable)		
	Character size : 12 × 18 dots (Vertical direction: 1 dot for 2H at × 1 setting.)		
	Enlarged characters : each × 2 settings in horizontal and vertical		
	Character interpolation : none		
	Line background color : 8-hue settable (settable in the row unit at menu display)		
	Line background intensity : 8 gradations settable in the row unit		
	Screen background color : 8-hue settable (at output of composite video signal)		
	Character color : white		
	Character intensity : 8 gradations settable in the row unit		
	Frame function : 1-dot frame in 4 directions		
	Frame intensity : 4 gradations settable in the row unit		
	Blinking : none (covered by software)		
Inverted character : settable in the character unit			
Halftone : none			
<b>Common:</b>	Input : composite video signal input (output level: 1 V <sub>[p-p]</sub> / 2 V <sub>[p-p]</sub> )		
	Clamp method : sync chip clamp, clamp level in 4 levels		
	Output : composite video output		
	Measure against image fluctuation : built-in AFC circuit		
	Dot clock : 1/2 of OSC oscillation clock (automatic phase adjustment)		
<b>XDS</b>	Built-in U.S. closed caption data slicer (optional 1 line data can be extracted.)		
<b>ROM Correction</b>	Correcting address designation: up to 3 addresses possible		
	Correction method: correction program being saved in internal RAM		
<b>I/O Pins</b>	<b>I/O</b>	56	• Common use: 56 ports 0, 1, 2, 4, 6, 7, B (by bit)
	<b>Input</b>	1	• Common use: 1
<b>A/D Inputs</b>	8-bit × 11-ch. (without S/H)		
<b>PWM</b>	13-bit × 2-ch. (at repetition cycle 572 μs, 14.32 MHz),		
	8-bit × 1-ch. (at repetition cycle 35.7 μs, 14.32 MHz)		
<b>ICR</b>	18-bit × 6-ch.		
<b>OCR</b>	16-bit × 7-ch. , 8-bit × 1-ch.		
<b>Special Ports</b>	3-state output (PTO) VLP pin; synchronous output: 7; 3-state synchronous output: 4; CTL amp; built-in FG amp; output of 1/4 OSC oscillation clock (1 V <sub>[p-p]</sub> )		
<b>Notes</b>	VISS/VASS detection function		

See the next page for electrical characteristics, pin assignment and support tool.

## Electrical Characteristics

### Supply current

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	
Operating supply current	IDD1	14.32 MHz operation without load, VDD = 5 V		50	100	mA
	IDD2	1/1024 of 14.32 MHz operation without load, VDD = 2.7 V		2	5	mA
	IDD3	Stop of 14.32 MHz oscillation, VDD = 2.7 V 32 kHz oscillation operation without load		50	100	μA
Supply current at STOP	IDSP	Stop of oscillation without load, VDD = 5 V			20	μA
Supply current at HALT	IDHT0	14.32 MHz oscillation without load, VDD = 5 V		5	15	mA
	IDHT1	Stop of 14.32 MHz oscillation, VDD = 2.7 V 32 kHz oscillation operation without load		5	20	μA

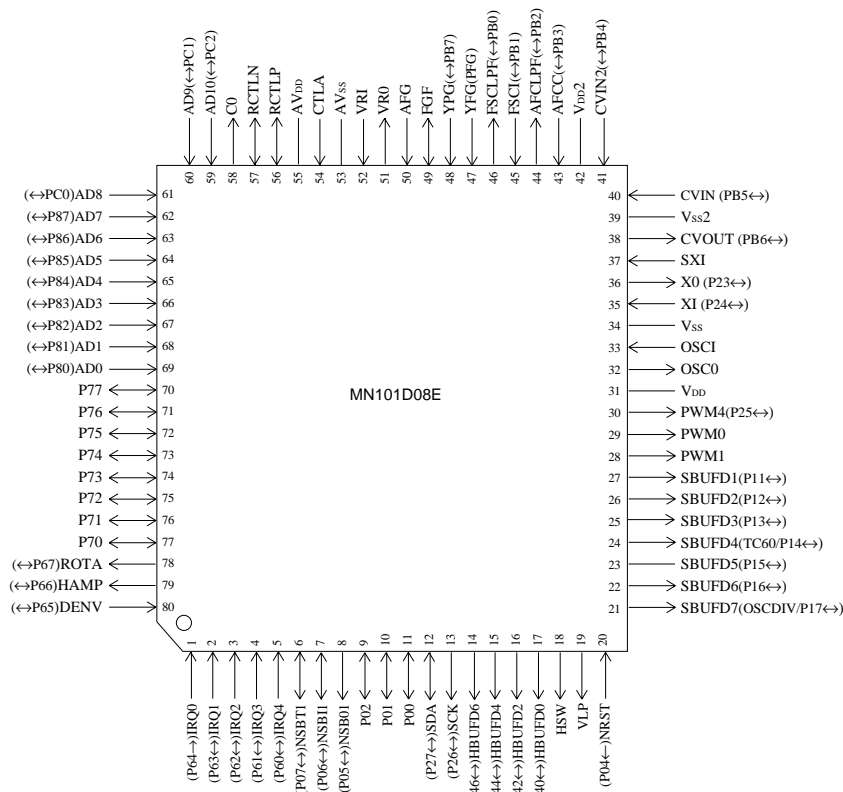
(Ta = 25°C ± 2°C, VSS = 0 V)

### A/D Converter Performance

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	
Conversion relative error	ΔNLAD				± 3	LSB
A/D Conversion Time	tAD	fosc = 14.32 MHz		8		μs
Analog Input Voltage					5	V

(Ta = 25°C ± 2°C, VDD = 5.0 V, VSS = 0 V)

Pin Assignment



LQFP080-P-1414A \*Lead-free

Support Tool

<b>In-circuit Emulator</b>	PX-ICE101C / D + PX-PRB101D08-LQFP080-P-1414A	
<b>Flash Memory Built-in Type</b>	Type	MN101DF08G [ES (Engineering Sample) available]
	ROM (× 8-bit)	128 K
	RAM (× 8-bit)	4 K
	Minimum instruction execution time	0.1397 μs (at 4.0 V to 5.5 V, 14.32 MHz) 71.5 μs (at 2.7 V to 5.5 V, fixed to 14.32 MHz internal division)
	Package	LQFP080-P-1414A *Lead-free

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